



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

SHIMODA, et al.

Serial No.:

10/521,470

Filed:

January 18, 2005

Title:

Multilayer Wiring Board, Manufacturing Method Thereof,

Semiconductor Device, and Wireless Electronic Device

Group:

2812

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

January 26, 2007

Sir:

Enclosed is a copy of the Filing Receipt for the above-identified application which incorrectly states the tenth inventor's first name as Kazumori. It should read Kazunori.

The correction is shown on the attached copy of the filing receipt. Issuance of a corrected filing receipt is respectfully requested. The changes are supported by the Declaration filed on January 8, 2005, copy attached herewith.

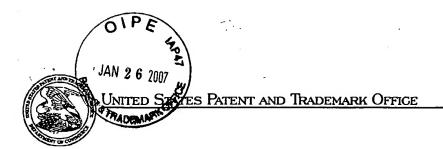
Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

William I. Solomon

Registration No. 28,565

WIS/stv Attachments



UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address COMMISSIONER FOR PATENTS PO. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

FILING OR 371 ART UNIT APPL NO. FIL FEE REC'D ATTY.DOCKET NO DRAWINGS TOT CLMS IND CLMS (c) DATE 40/521,470 \01/18/2005 2812 13250 \1204.44657X00 \7 \ 59 15

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CONFIRMATION NO. 2249

FILING RECEIPT

OC00000017562916

20457 ANTONELLI, TERRY, STOUT & KRAUS, LLP 1300 NORTH SEVENTEENTH STREET SUITE 1800 ARLINGTON, VA 22209-3873

Date Mailed: 12/05/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Yasushi Shimada, Tsukuba-shi, Ibaraki, JAPAN;
Yoshitaka Hirata, Shimodate-shi, Ibaraki, JAPAN;
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Assignment For Published Patent Application

Hitachi Chemical Co., Ltd., Tokyo, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 20457.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/06860 05/30/2003

Foreign Applications

VAPAN 2002-209650 07/18/2002 VAPAN 2002-209639 07/18/2002 VAPAN 2002-259291 09/04/2002 VAPAN 2002-259284 09/04/2002 VAPAN 2002-324238 11/07/2002 Projected Publication Date: 03/09/2006

Non-Publication Request: No

Early Publication Request: No

Title

Multilayer wiring board, method for producing the same, semiconductor device and radio electronic device

Preliminary Class

438

PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process simplifies the filing of patent applications on the same invention in member countries, but does not result in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

Applicants also are advised that in the case of inventions made in the United States, the Director of the USPTO must issue a license before applicants can apply for a patent in a foreign country. The filing of a U.S. patent application serves as a request for a foreign filing license. The application's filing receipt contains further information and guidance as to the status of applicant's license for foreign filing.

Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at http://www.uspto.gov/web/offices/pac/doc/general/index.html.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, http://www.stopfakes.gov. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

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Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15

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NOT GRANTED

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a license under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any indication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).

Attorney's Docket No.:

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that: my residence, post office address and country of citizenship are as stated below, next to my name; I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

or PCT International Application Number __PCT/JP2003/006860

I hereby state that I have reviewed and understand the contents of the above-identified specification,

including the claim(s), as amended by any amendment referred to above. I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations,

(if applicable)

MULTILAYER WIRING BOARD, MANUFACTURING METHOD THEREOF, SEMICONDUCTOR DEVICE, AND WIRELESS ELECTRONIC DEVICE the specification of which is attached hereto.

and was amended on November 3, 2003

30/05/2003

United States Application Number

was filed on

Section 1.56.

foreign application(s) for pate	ent or inventor's certificate li	tle 35, United States Code, Sect sted below and have also identifing date before that of the applica	ned below any foreign
			Priority
Prior Foreign Application(s)		·	Claimed
2002-209650	Japan	18/07/2002	<u>x</u>
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
2002-209639	Japan	18/07/2002	_ <u>X</u>
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
2002-259291	Japan	04/09/2002	X
(Number)	(Country)	(Day/Month/Year Filed)	X Yes No
2002-259284	Japan	04/09/2002	x
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
2002-324238	Japan	07/11/2002	_x_
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
I hereby claim the benefit un application(s) listed below	der title 35, United States (Code, Section 119(e) of any Un	ited States provisiona
(Application Number)	Filing Date		
(Application Number)	Filing Date	•	

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States

application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose all information known to me to be material to

patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Number)

Filing Date

(Status -- patented,

pending, abandoned)

(Application Number)

Filing Date

(Status -- patented,

pending, abandoned)

· 3.

I hereby appoint: Donald R. Antonelli, Reg. No. 20,296; Melvin Kraus, Reg. No. 22,466; William I. Solomon, Reg. No. 28,565; Gregory E. Montone, Reg. No. 28,141; Ronald J. Shore, Reg. No. 28,577; Donald E. Stout, Reg. No. 26,422; Alan E. Schiavelli, Reg. No. 32,087; James N. Dresser, Reg. No. 22,973; Carl I. Brundidge, Reg. No. 29,621; Paul J. Skwierawski, Reg. No. 32,173; and Robert M. Bauer, Reg. No. 34,487, my attorneys; of ANTONELLI, TERRY, STOUT & KRAUS, LLP with offices located at 1300 North Seventeenth Street, Suite 1800, Arlington, Virginia 22209, telephone: (703) 312-6600, fax: (703) 312-6666; with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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	Full Name of Eleventi Inventor's Signature _ Residence _ Post Office Address Full Name of Twelfth Inventor's Signature _	(City, St	ate) HI CHEMICAL COgawa, Shimodate- ate)	Citizenshi	h and Develor 8521 Japan Date Date	(Country) (Country) (Country)	
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	Full Name of Eleventi Inventor's Signature Residence Post Office Address Full Name of Twelfth Inventor's Signature Residence Post Office Address Full Name of Thirteer	(City, St	ate) HI CHEMICAL COgawa, Shimodate ate)	Citizenshi	h and Develor 8521 Japan Date Date Date	(Country) (Country) (Country)	
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